LINQALLOY SW-SAC305



SAC305 Solder Wire

- No-clean solder wire
- Lead Free and RoHS compliant
- Good wetting properties and non-splattering

LINQALLOY-SW-SAC305 is a lead free solder wire comprised of 96.5% tin, 3% silver, 0.5% copper that has been designed for electronic assembly soldering. **No-clean solder wire** is designed for applications where post-soldering cleaning is unnecessary, providing minimal, non-conductive residues.

The enhanced flux content (higher %) guarantees higher reliability and leaves behind minimal residues, resulting in exceptionally high insulation resistance and excellent reliability.

Chemical composition

Alloy	Chemical composition (wt.%)											
	Sn	Ag	Cu	Ni	Zn	Al	Sb	Fe	As	Bi	Cd	Pb
Sn96.5-Ag3.0 -Cu0.5	Bal.	3.0	0.5	0 ~ 0.01	0.002 [Max]	0.005 [Max]	0.05 [Max]	0.02 [Max]	0.03 [Max]	0.10 [Max]	0.002 [Max]	0.01 [Max]

Technical Specifications

Property	Value
Alloy	SAC305
Flux content [%]	1.0 ~ 2.8
Melting Point [°C]	217
Soldering Temperature [°C]	260~290
Tensile Strength [MPa]	30
Elongation at Break [%]	55
Expansion Rate [%]	≥ 80
Halogen Content	ROL0 / ROL1
Silver nitrate test	PASS
Copper corrosion	PASS
SIR [Ω]	≥4.7×10¹³
Water soluble resistance (Ω·cm)	>1×10⁵
Copper Mirror	PASS

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Solder Wire Diameters and Packaging

Diameter [mm]	Packaging				
Ф0.5, Ф0.6, Ф0.8, Ф1.0, Ф1.2, Ф2.0	1.Paper box packaging 2.Quantity per Box: 10 rolls				

Storage and handling:

General:

- Store unopened solder wire in its original container in a cool, **dry environment**.
- Maintain a constant temperature and humidity level for optimal storage.
- Ideal conditions are:
 - Temperature: Below normal room temperature (around 22°C / 72°F)
 - Relative Humidity: Less than 80%
- Implement a First-In-First-Out (FIFO) inventory system to ensure proper stock rotation and use older solder first.
- Minimize exposure to light and contaminants.

Shelf Life:

Typically up to 2 years from the manufacture date when stored properly.

Handling:

- Wash hands before handling solder wire to minimize contamination.
- Avoid excessive bending or flexing of the wire, which can cause damage.
- Wear appropriate gloves when handling solder wire, especially lead-containing varieties.
- After use, reseal the container tightly to prevent moisture absorption and contamination.



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